

300mA LOW POWER LDO

Overview

SL73xx is a low drop-out linear voltage regulator with the CMOS technology. The maximum output current is 300mA, and the allowed maximum input withstanding voltage is +48V. The device has several fixed output voltage values, with ranges from 1.8V to 5.0V. The COMS technology can ensure the characteristics of low drop-out and low quiescent current.

Functional characteristics

- ★ Low power consumption
- ★ low dropout
- ★ Relatively low temperature coefficient
- ★ Maximum input withstanding voltage: +48V
- ★ Typical quiescent current: 3uA
- ★ Maximum output current: 300mA
- ★ Output voltage accuracy: ±2%
- ★ Package type: SOT23-3, SOT89

Application fields

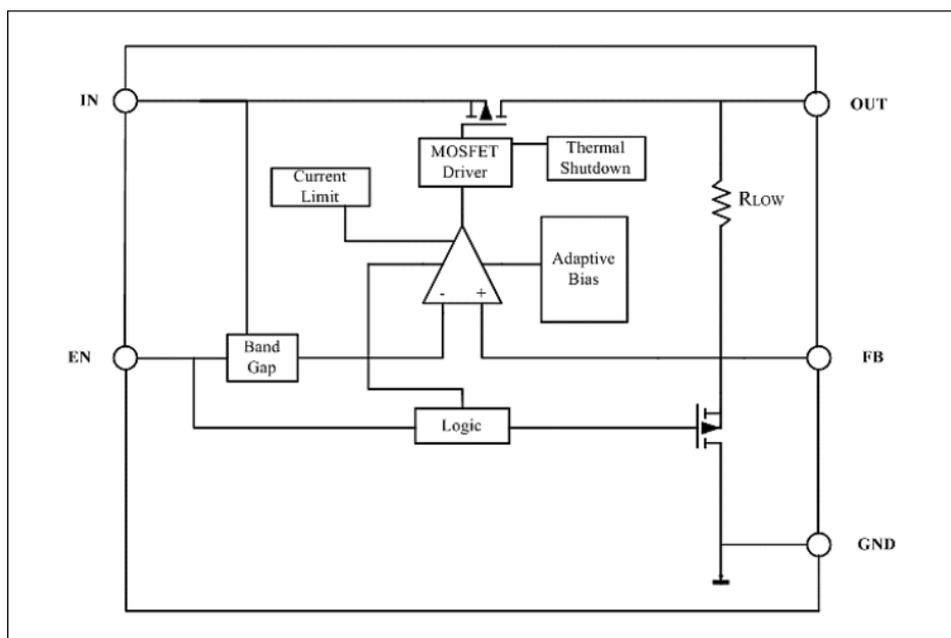
- ★ A device with power supply of batteries,
- ★ A communication device
- ★ An audio/video device

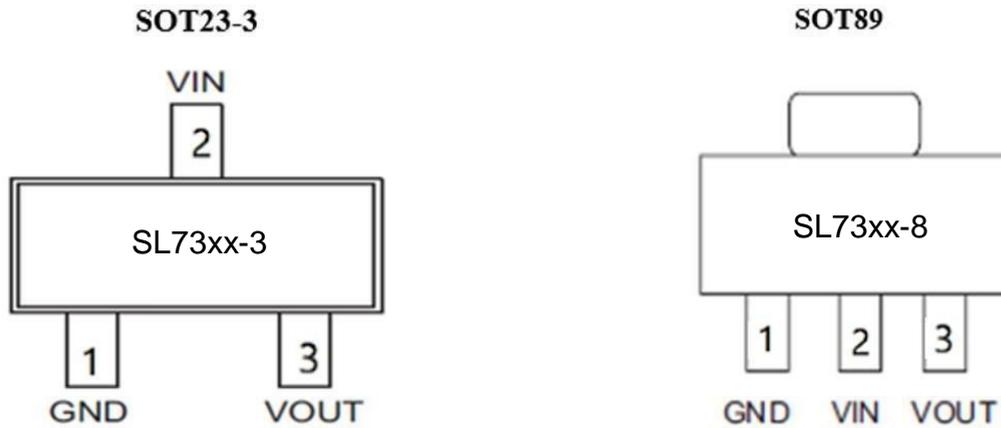
Table of model selection

Model	Output voltage	Package type	Positive printing
SL 7318-x	1.8V	SOT23-3 SOT89	73xx-3(packaged as SOT23 -3) 73xx-8(packaged as SOT89 -3)
SL 7325-x	2.5V		
SL 7330-x	3.0V		
SL 7333-x	3.3V		
SL 7336-x	3.6V		
SL 7344-x	4.4V		
SL 7350-x	5.0V		

Notes: "xx" represents for the output voltage.

Circuit functional block diagram



Pin drawing

Pin instruction

No. of pins	Name of pins	Description
1	GND	Ground
2	VIN	Power supply input pin
3	VOUT	Output pin, required to be connected to the ground with a capacitor higher than 1uF

Absolute parameters

	Description	Values	Units
Vin	Input voltage	0~+45(Note1)	V
Vout	Output voltage	1.8~5.0	V
T _{STG}	Storage temperature	-45~+140	°C
T _{WK}	Working temperature	-40~+85	°C
ESD _{HBM}	Human body mode	4000(Note2)	V
CDM	voltage live device model	1500(Note2)	V
Latch up	Latch maximum rated current value	200(Note2)	mA

Only rated power is emphasized here; working with the power out of the ranges of the absolute parameters will lead to damages to the chip, and it is difficult to expect the working state of the chip out of the ranges marked above; in addition, long-term working out of the marked ranges may lead to influences on reliability of the chip.

Note 1: Refer to electrical characteristics and application information.

Note2: The ESD protection of the series of products has been tested with the following testing methods:

The ESD human body mode is tested according to EIA/JESD22-A114.
 The electrostatic discharging ability is tested according to JESD22-C101.
 The latch maximum current value is tested according to JEDEC78.

Suggested working conditions

Parameters	Description	Ranges	Units
V_{IN}	Input voltage	+2.5~+45	V
I_{OUT}	Output current	0~300	mA
T_A	Working temperature	-40~+85	°C
C_{IN}	Capacitor pol on the input end	1~10	uF
C_{OUT}	Capacitor pol on the output end	1~10	uF
ESR	The equivalent resistance value on the input end and the output end	5~100	mΩ

Thermal energy information

Symbols	Parameters	Package type	Max. value	Units
θ_{JA}	Thermal resistance (connecting with environment) (assumed with no environment airflow or cooling fin)	SOT23-3	360	°C/W
		SOT89	135	°C/W
P_D	Power consumption	SOT23-3	0.2	W
		SOT89	0.5	W

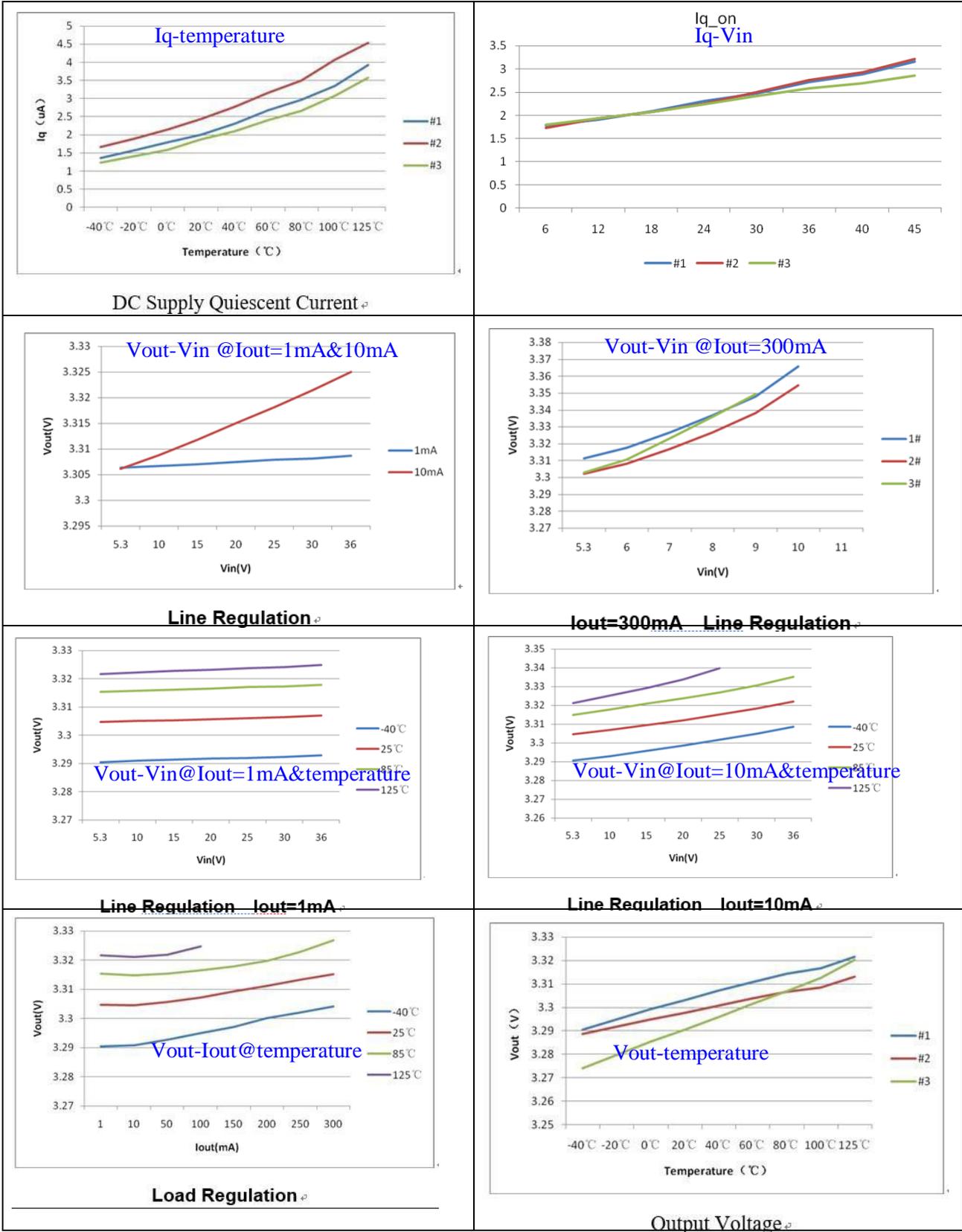
Notes: The P_D value is measured at $T_a=25^\circ\text{C}$.

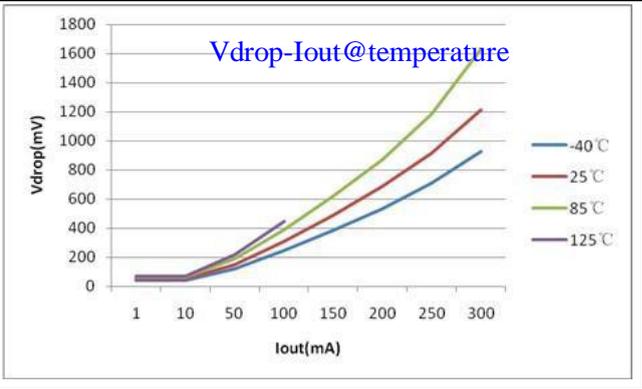
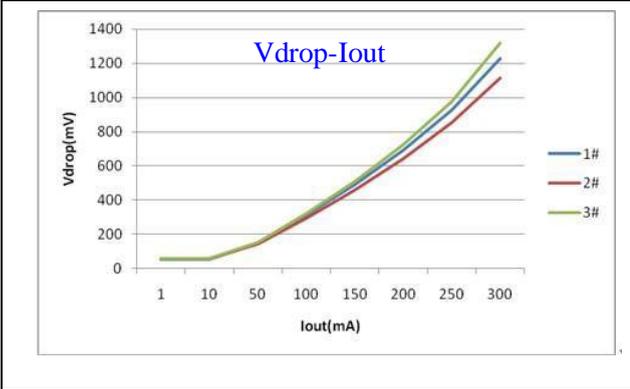
Electrical characteristics
 $T_a=25^{\circ}\text{C}$

Symbols	Parameters	Testing conditions	Min.	Typical	Max.	Units
V_{IN}	Input voltage	—	—	—	+45	V
V_{OUT}	Output voltage	$T_A=+25^{\circ}\text{C}$	-2%		+2%	V
		$-40^{\circ}\text{C}\leq T_A\leq+85^{\circ}\text{C}$	-3%		+3%	V
V_{DROP}	Dropout voltage $I_{OUT}=300\text{mA}$	$V_{OUT}=1.8\text{V}$	—	1350	1650	mV
		$V_{OUT}=2.5\text{V}$	—	1150	1450	mV
		$V_{OUT}=2.8\text{V}$	—	1100	1400	mV
		$V_{OUT}=3.0\text{V}$	—	1050	1350	mV
		$V_{OUT}=3.3\text{V}$	—	1000	1300	mV
		$V_{OUT}=4.4\text{V}$	—	950	1250	mV
		$V_{OUT}=5\text{V}$	—	900	1200	mV
I_{OUT}	Output current	$V_{IN}=V_{OUT}+2\text{V}$	—	300	—	mA
$Load_{Reg}$	Load regulation ratio	$1\text{mA}\leq I_{OUT}\leq 300\text{mA}$ $V_{IN}=V_{OUT}+1\text{V}$	—	—	40	mV
I_{LMT}	Limited current	$V_{IN}=V_{OUT}+1\text{V}$	300	450	—	mA
I_{SHORT}	Short circuit limited current	$V_{OUT}=0\text{V}$	—	100	—	mA
I_Q	Quiescent current	No load ($I_{OUT}=0\text{mA}$)	—	3	4.0	μA
$PSRR$	Power supply rejection ratio	$V_{IN}=V_{OUT}+1\text{V}$, $I_{OUT}=20\text{mA}$ $f=1\text{KHz}$	—	60	—	dB
eN	Output Noise Voltage	$V_{IN}=V_{OUT}+1\text{V}$, $I_{OUT}=1\text{mA}$ $f=10\text{Hz}\sim 100\text{KH}$ $Z(V_{OUT}=3\text{V})$ $C_{out}=1\mu\text{F}$	—	100	—	μVrms
R_{LOW}	Output discharge resistance	$C_{IN}=4\text{V}$, $V_{en}=0\text{V}$	—	70	—	Ω
$\frac{\Delta V_{OUT}}{\Delta V_{IN}\times V_{OUT}}$	Input voltage regulation ratio	$V_{O}+1\text{V}\leq V_{IN}\leq 45\text{V}$ $I_{OUT}=1\text{mA}$	—	—	0.2	%/V
$\frac{\Delta V_{OUT}}{\Delta T_a\times V_{OUT}}$	Temperature coefficient	$I_{OUT}=10\text{mA}$ $-40^{\circ}\text{C}<T_a<85^{\circ}\text{C}$	—	100	—	ppm/ $^{\circ}\text{C}$

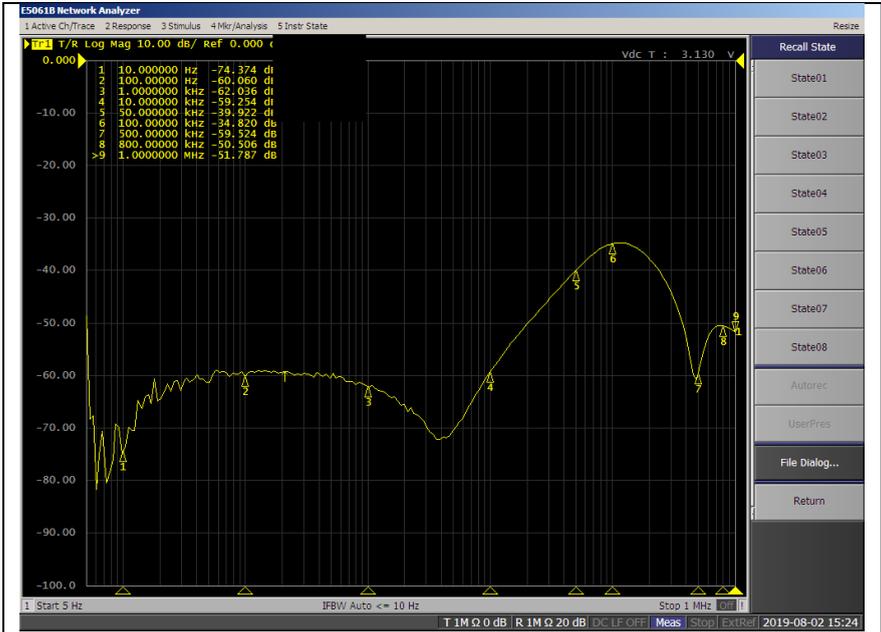
Notes: Make the output voltage drop by 2% in the condition of $V_{IN}=V_{OUT}+2\text{V}$ and a fixed load; the difference of the input voltage and the output voltage at this time is the Dropout voltage.

Typical performance characteristics

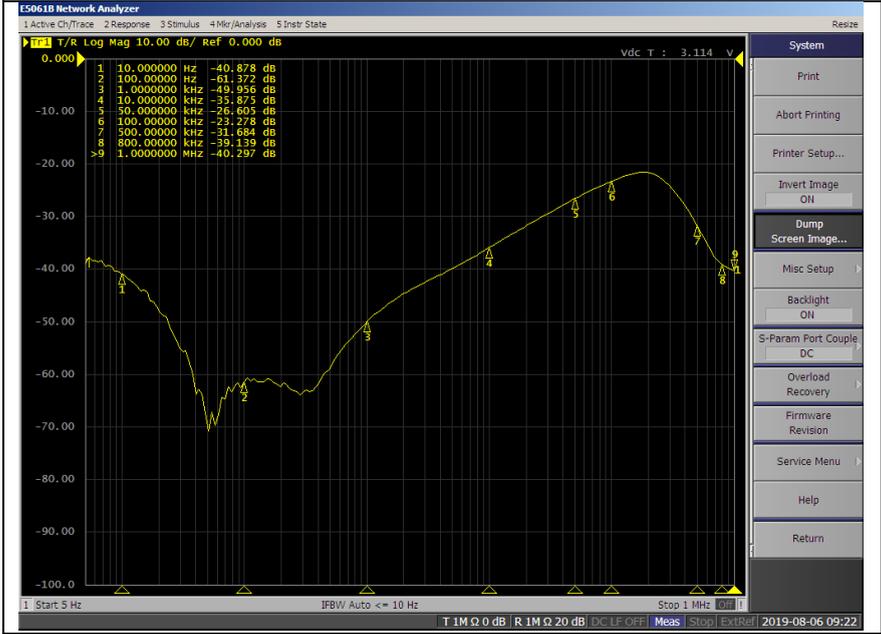




PSSR:

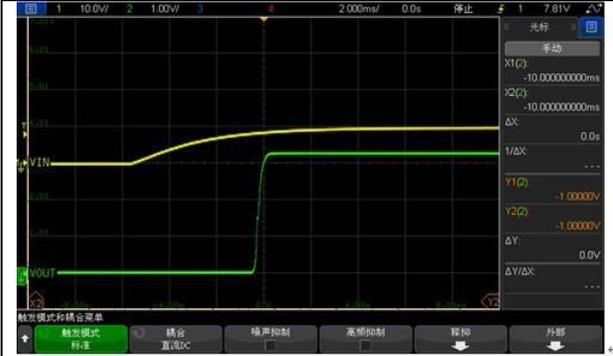


PSSR @ Iout=20mA

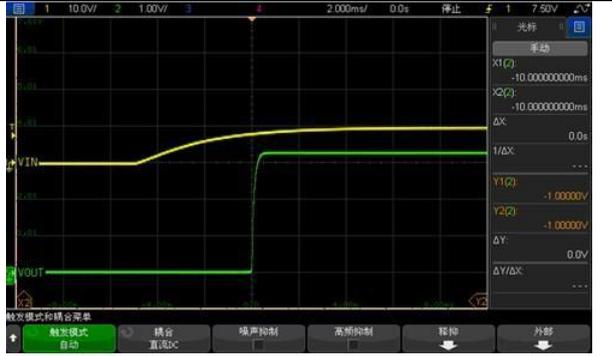


PSSR @ Iout=300mA

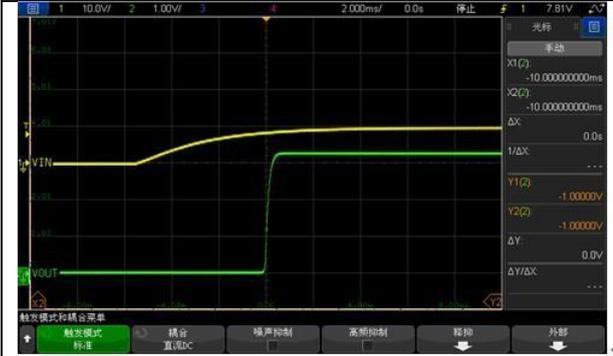
Starting characteristic:



Vin=10V, Iout=0mA, Cout=0.1uF



Vin=10V, Iout=0mA, Cout=10uF



Vin=10V, Iout=30mA, Cout=0.1uF



Vin=10V, Iout=30mA, Cout=10uF



Vin=30V, Iout=0mA, Cout=0.1uF



Vin=30V, Iout=0mA, Cout=10uF



Vin=30V, Iout=30mA, Cout=0.1uF



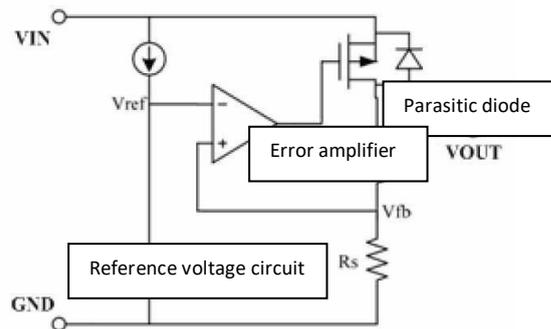
Vin=30V, Iout=30mA, Cout=10uF

Current-limiting protection

With the current-limiting protection function, it can prevent the device from damages in condition of overloading or short circuit. The current is tested by the internal induction transistor.

Functional description

The error amplifier compares the input voltage V_{fb} , which is the divider resistance composed by the feedback resistance R_s and R_f , with the reference voltage V_{ref} . Provide necessary gate pole voltage to the output transistor through the error amplifier, to prevent the output voltage from influences of the input voltage or the temperature, to kept it unchanged.



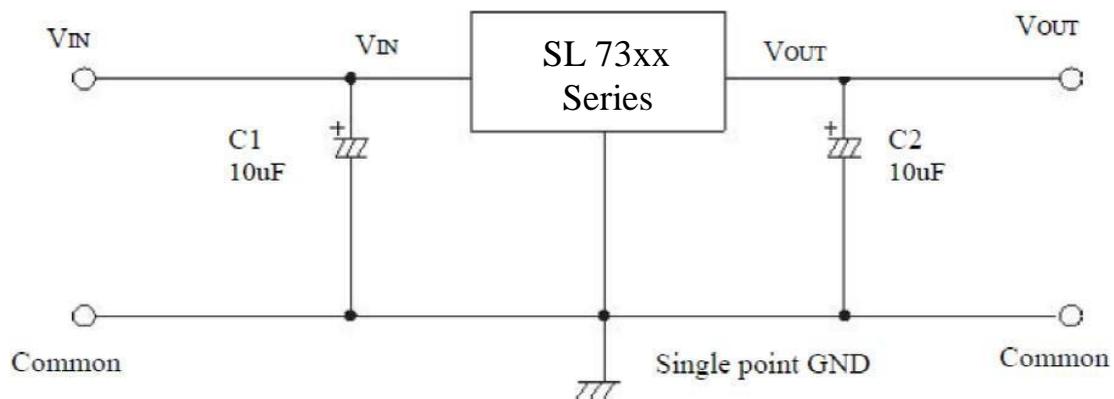
Matters needing attention:

- 1) The phase compensation and the ESR of the output capacitor are utilized in the circuit for compensation; therefore, it is suggested to connect a capacitor larger than 1uF between the output and the ground.
- 2) It is suggested to use a polar capacitor of 10uF for the input and the output, and try to make the capacitor get closer to the pins of VIN and VOUT of LDO.
- 3) Pay attention to using conditions of the input and output voltage and the loading current, to prevent the condition that the internal power consumption (PD) of IC exceeds the allowed maximum power consumption by package.

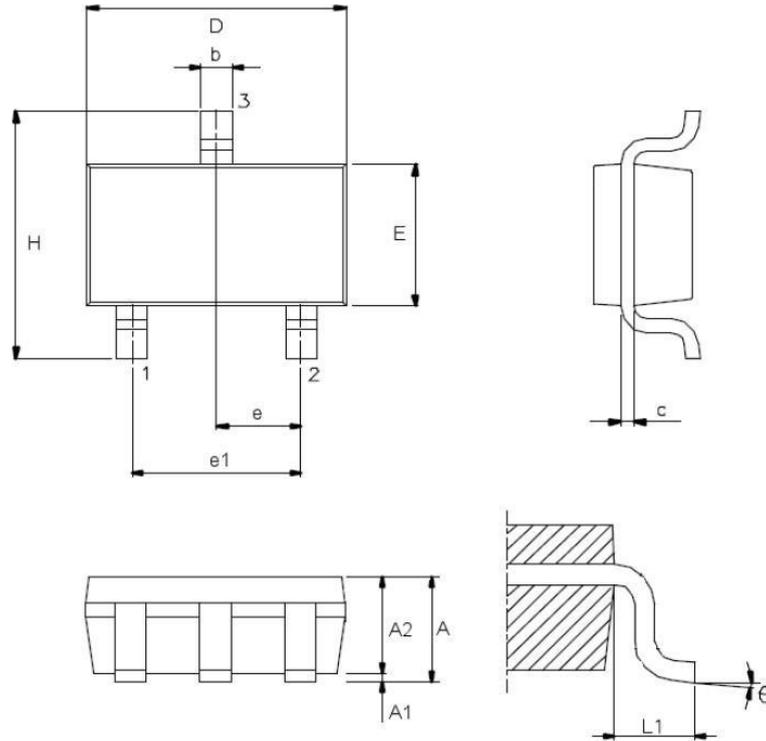
The calculation method of PD: $PD = (VIN - VOUT) \times IO_{OUT}$

For example: SL 7350-8, SOT89 package, when $VIN = 12V$, $IO_{OUT} = 100mA$, $PD = (12 - 5) \times 100mA = 0.7W$,

It may lead to damage to IC if it exceeds 0.5W than the specified value. With respect to the PD value of different package modes, please refer to the column of "thermal energy information".

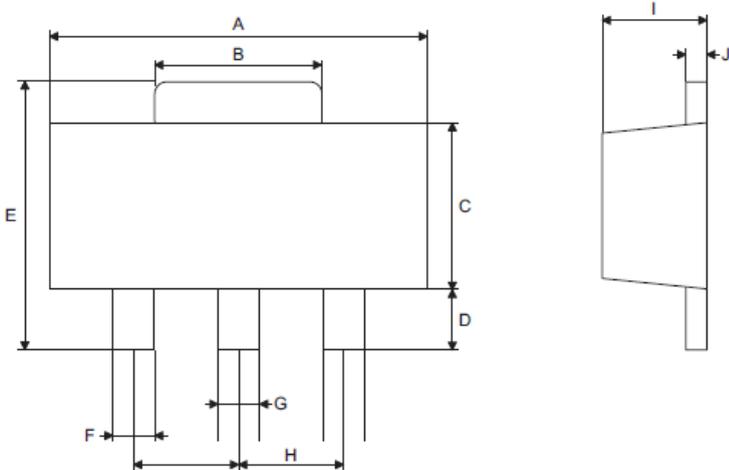
Typical application circuit**Layout suggestions:**

1. Try to make the input and the output capacitor get closer to the device.
2. Conduct device connection with a copper plane, to optimize the thermal performance.
3. Arrange simulated thermal vias around the device, to make thermal energy dispersed.

Package information
SOT23-3 package dimension


Symbols	Dimension (nits: mm)		
	Min.	Typical	Max.
A	—	—	1.45
A1	—	—	0.15
A2	0.90	1.15	1.30
b	0.30	—	0.50
C	0.08	—	0.22
D	—	2.90	—
E	—	1.60	—
e	—	0.95	—
e1	—	1.90	—
H	—	2.80	—
L1	—	0.60	—
θ	0°	—	9°

SOT89 package dimension



Symbols	Size (nits: mm)		
	Min.	Typical	Max.
A	4.40	—	4.60
B	1.35	—	1.83
C	2.29	—	2.60
D	0.89	—	1.20
E	3.94	—	4.25
F	0.36	—	0.48
G	0.44	—	0.56
H	—	1.50	—
I	1.40	—	1.60
J	0.35	—	0.44